



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
		1.5Ω @ V <sub>GS</sub> = 4.5V	0.40A
01	001/	2.0Ω @ V <sub>GS</sub> = 2.5V	0.35A
Q1	30V	3.0Ω @ V <sub>GS</sub> = 1.8V	0.28A
		4.5Ω @ V <sub>GS</sub> = 1.5V	0.23A
	Q2 -30V	5Ω @ V <sub>GS</sub> = -4.5V	-0.22A
		6Ω @ V <sub>GS</sub> = -2.5V	-0.20A
Q2		7Ω @ V <sub>GS</sub> = -1.8V	-0.18A
		10Ω @ V <sub>GS</sub> = -1.5V	-0.15A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

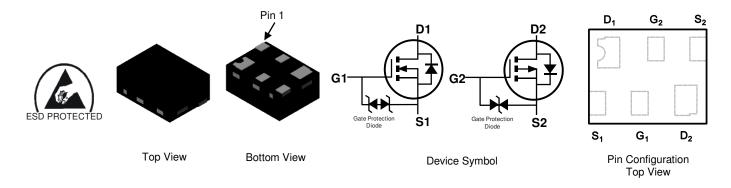
- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

### **Features and Benefits**

- Low On-Resistance
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 0.8mm x 0.6mm
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: X2-DFN0806-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.027 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMC31D5UDA-7B	X2-DFN0806-6	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

### **Marking Information**

Notes:



B6 = Product Type Marking Code Bar denotes Pin 1

**Top View** 

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## Maximum Ratings Q1 N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit	
Drain-Source Voltage			V <sub>DSS</sub>	30	V	
Gate-Source Voltage			V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 5) $V_{GS}$ = 4.5V	,	T <sub>A</sub> = +25°C	- I <sub>D</sub>	0.4	٨	
		T <sub>A</sub> = +70°C		0.32	A	
Maximum Continuous Body Diode Forward Current (Note 6)			ls	0.8	А	
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	0.8	А	

## Maximum Ratings Q2 P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
Drain-Source Voltage			V <sub>DSS</sub>	-30	V	
Gate-Source Voltage			V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 5) $V_{GS}$ = -4.5V		$T_A = +25^{\circ}C$	- I <sub>D</sub>	-0.22	٨	
		T <sub>A</sub> = +70°C		-0.17	A	
Maximum Continuous Body Diode Forward Current (Note 6)			I <sub>S</sub>	-0.8	А	
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	-0.8	A	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.37	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	345	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	O°

## **Electrical Characteristics Q1 N-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)		1	71	1		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	; I <sub>DSS</sub>	—	—	100	nA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±10	μΑ	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	0.7	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		—	1.2	1.5		$V_{GS} = 4.5V, I_D = 100mA$
Static Drain-Source On-Resistance	Passa	—	1.3	2.0	Ω	$V_{GS} = 2.5V, I_D = 50mA$
	R <sub>DS(ON)</sub>	—	1.5	3.0		$V_{GS} = 1.8V, I_D = 20mA$
		—	1.8	4.5		$V_{GS} = 1.5V, I_D = 10mA$
Diode Forward Voltage	V <sub>SD</sub>	—	0.6	1.0	V	$V_{GS} = 0V, I_{S} = 10mA$
DYNAMIC CHARACTERISTICS (Note 8)						·
Input Capacitance	Ciss	—	22.6	—	pF	
Output Capacitance	Coss	—	2.68	—	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	1.8	—	pF	
Total Gate Charge	Qg	—	0.38	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	—	0.05	—	nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 15V, I <sub>D</sub> = 200mA
Gate-Drain Charge	Q <sub>gd</sub>	—	0.07	_	nC	ID = 200IIIA
Turn-On Delay Time	t <sub>D(ON)</sub>		3.2		ns	
Turn-On Rise Time	t <sub>R</sub>	—	2.2	_	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time		—	21	_	ns	$R_g = 2\Omega, I_D = 200 \text{mA}$
Turn-Off Fall Time	tF	—	7.5	—	ns	1

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



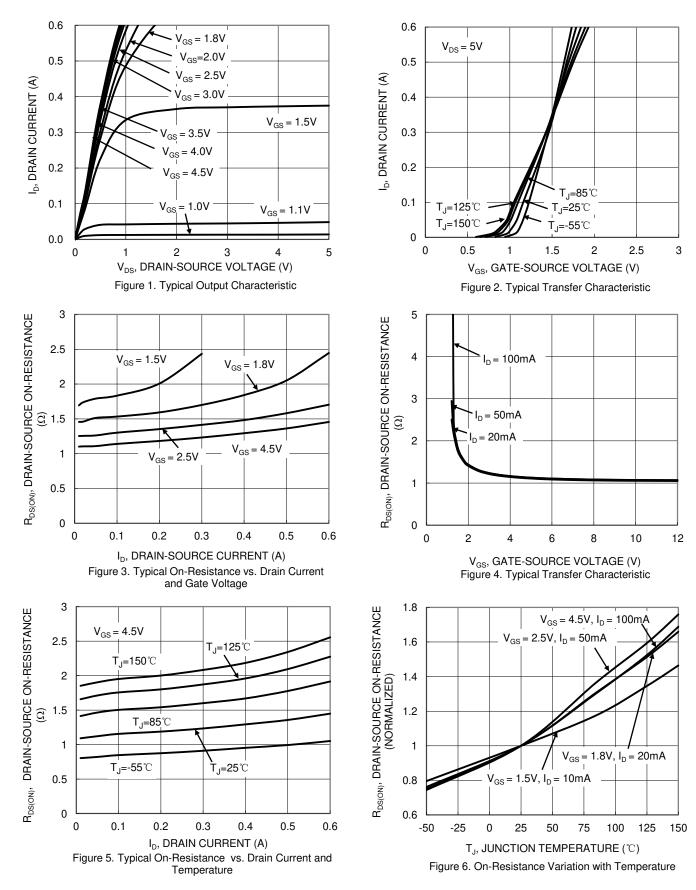
# Electrical Characteristics Q2 P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30		—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	I <sub>DSS</sub>	_		-100	nA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—		±10	μΑ	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	-0.7	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
		—	1.8	5		$V_{GS} = -4.5V, I_D = -100mA$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	2.3	6	Ω	$V_{GS} = -2.5V, I_D = -50mA$
Static Drain-Source On-Resistance		_	3	7		$V_{GS} = -1.8V, I_D = -20mA$
		_	3.4	10		$V_{GS} = -1.5V, I_D = -10mA$
Diode Forward Voltage	V <sub>SD</sub>	_	-0.6	-1.0	V	$V_{GS} = 0V, I_{S} = -10mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	21.8	—	pF	
Output Capacitance	Coss	_	2.82	—	pF	− V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, − f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	1.66	—	pF	
Total Gate Charge	Qg	_	0.35	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	0.05	—	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$
Gate-Drain Charge	Q <sub>gd</sub>		0.10	_	nC	$-I_{D} = -200 \text{mA}$
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.5	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	5.2	_	ns	$V_{DD} = -15V, V_{GS} = -4.5V,$
Turn-Off Delay Time		_	18.8	—	ns	$R_{g} = 2\Omega, I_{D} = -200 mA$
Turn-Off Fall Time	t <sub>F</sub>	_	8.7	—	ns	7

 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



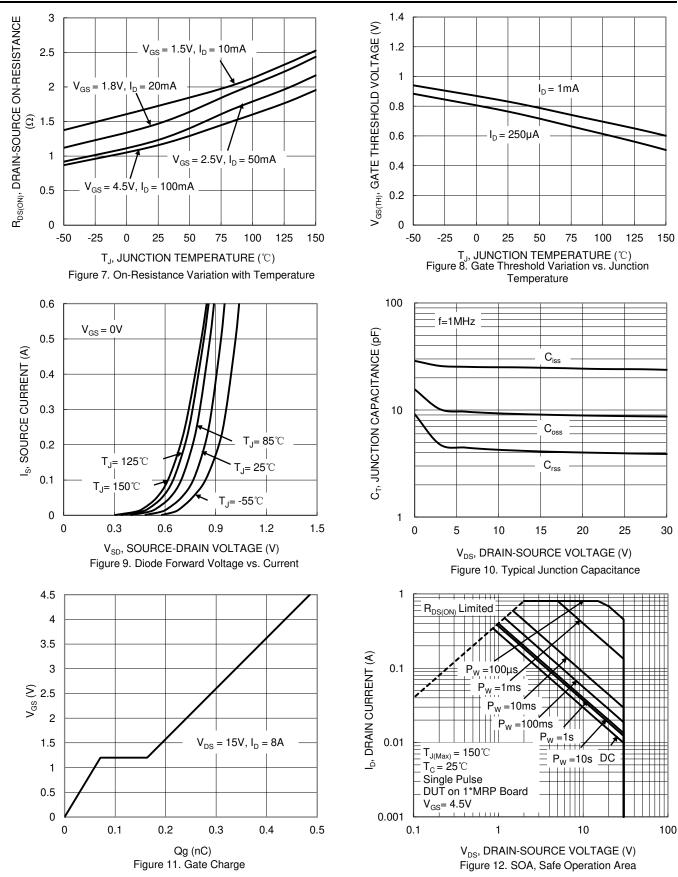
### **Typical Characteristics - N-CHANNEL**



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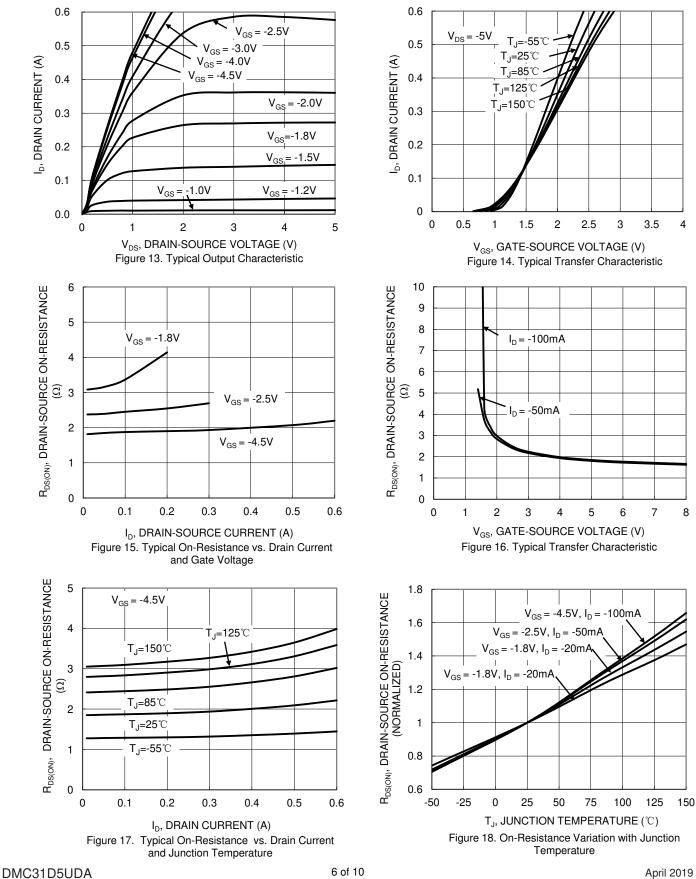


# Typical Characteristics - N-CHANNEL (continued)





## **Typical Characteristics - P-CHANNEL**

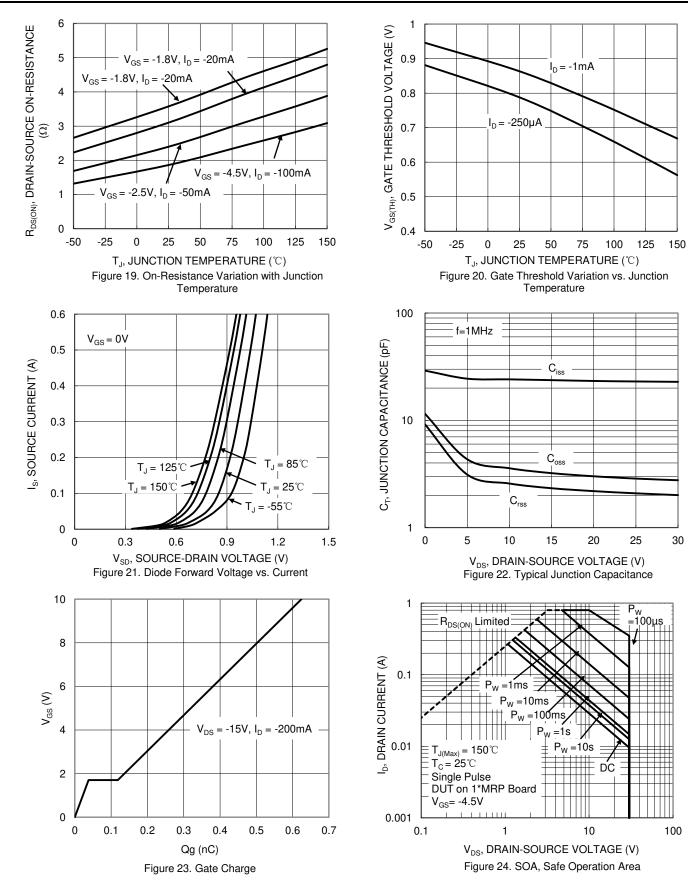


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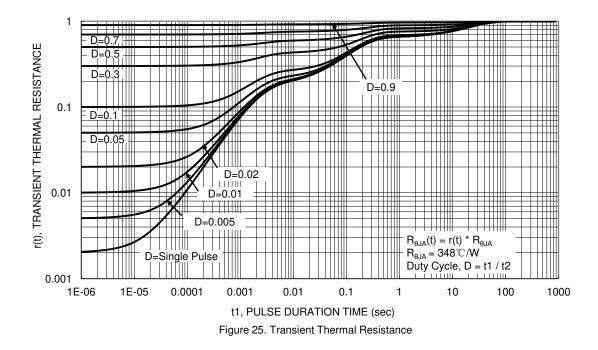
### Typical Characteristics - P-CHANNEL (continued)



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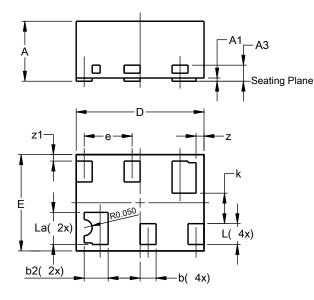




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DFN0806-6

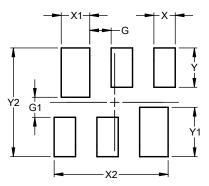


X2-DFN0806-6						
Dim	Min	Max	Тур			
Α		0.40	0.36			
A1	0.00	0.03	0.02			
A3			0.10			
b	0.07	0.15	0.10			
b2	0.10	0.20	0.15			
D	0.75	0.85	0.80			
E	0.55	0.65	0.60			
е			0.30			
k			0.19			
L	0.10	0.18	0.13			
La	0.17	0.25	0.20			
z			0.05			
z1			0.04			
All	All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0806-6



Dimensions	Value (in mm)
G	0.150
G1	0.140
X	0.150
X1	0.200
X2	0.800
Y	0.275
Y1	0.345
Y2	0.760



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